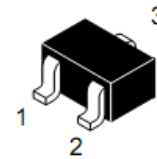


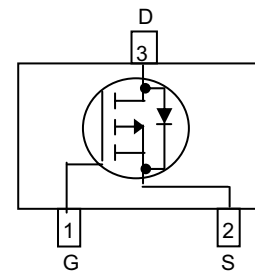
**WPM3012**

Single P-Channel, -30V, -3.1A, Power MOSFET

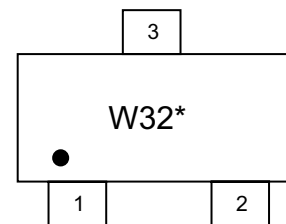
V <sub>DS</sub> (V)	R <sub>ds(on)</sub> (Ω)
-30	0.058@ V <sub>GS</sub> =-10V
	0.080@ V <sub>GS</sub> =-4.5V



**SOT-23**



**Pin configuration (Top view)**



W32= Device Code  
\* = Month (A~Z)

**Marking**

**Descriptions**

The WPM3012 is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent R<sub>DS (ON)</sub> with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product WPM3012 is Pb-free and Halogen-free.

**Features**

- Trench Technology
- Supper high density cell design
- Excellent ON resistance for higher DC current
- Extremely Low Threshold Voltage
- Small package SOT-23

**Applications**

- Driver for Relay, Solenoid, Motor, LED etc.
- DC-DC converter circuit
- Power Switch
- Load Switch
- Charging

**Order information**

Device	Package	Shipping
WPM3012-3/TR	SOT-23	3000/Reel&Tape

### Absolute Maximum ratings

Parameter		Symbol	10 S	Steady State	Unit
Drain-Source Voltage		$V_{DS}$	-30		V
Gate-Source Voltage		$V_{GS}$	±20		
Continuous Drain Current <sup>a</sup>	$T_A=25^{\circ}\text{C}$	$I_D$	-3.1	-2.9	A
	$T_A=70^{\circ}\text{C}$		-2.5	-2.3	
Maximum Power Dissipation <sup>a</sup>	$T_A=25^{\circ}\text{C}$	$P_D$	0.9	0.8	W
	$T_A=70^{\circ}\text{C}$		0.6	0.5	
Continuous Drain Current <sup>b</sup>	$T_A=25^{\circ}\text{C}$	$I_D$	-2.8	-2.6	A
	$T_A=70^{\circ}\text{C}$		-2.2	-2.1	
Maximum Power Dissipation <sup>b</sup>	$T_A=25^{\circ}\text{C}$	$P_D$	0.7	0.6	W
	$T_A=70^{\circ}\text{C}$		0.5	0.4	
Pulsed Drain Current <sup>c</sup>		$I_{DM}$	-15		A
Operating Junction Temperature		$T_J$	150		°C
Lead Temperature		$T_L$	260		°C
Storage Temperature Range		$T_{stg}$	-55 to 150		°C

### Thermal resistance ratings

Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance <sup>a</sup>	$t \leq 10 \text{ s}$	$R_{\theta JA}$	105	130	°C/W
	Steady State		120	155	
Junction-to-Ambient Thermal Resistance <sup>b</sup>	$t \leq 10 \text{ s}$	$R_{\theta JA}$	130	160	
	Steady State		145	190	
Junction-to-Case Thermal Resistance		$R_{\theta JC}$	60	75	

a Surface mounted on FR-4 Board using 1 square inch pad size, 1oz copper

b Surface mounted on FR-4 board using minimum pad size, 1oz copper

c Pulse width<380µs, Duty Cycle<2%

d Maximum junction temperature  $T_J=150^{\circ}\text{C}$ .

**Electronics Characteristics (Ta=25°C, unless otherwise noted)**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-to-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0\text{ V}, I_D = -250\mu\text{A}$	-30			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -24\text{V}, V_{GS} = 0\text{V}$			-1	$\mu\text{A}$
Gate-to-source Leakage Current	$I_{GSS}$	$V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{V}$			$\pm 100$	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_D = -250\mu\text{A}$	-1.5	-1.9	-2.5	V
Drain-to-source On-resistance <sup>b, c</sup>	$R_{DS(on)}$	$V_{GS} = -10\text{V}, I_D = -3.1\text{A}$		58	68	m $\Omega$
		$V_{GS} = -4.5\text{V}, I_D = -2.8\text{A}$		80	95	
Forward Transconductance	$g_{FS}$	$V_{DS} = -5\text{ V}, I_D = -5.0\text{A}$		8.2		s
<b>CAPACITANCES, CHARGES</b>						
Input Capacitance	$C_{ISS}$	$V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz},$ $V_{DS} = -20\text{V}$		654		pF
Output Capacitance	$C_{OSS}$			67		
Reverse Transfer Capacitance	$C_{RSS}$			56		
Total Gate Charge	$Q_{G(TOT)}$	$V_{GS} = -10\text{ V},$ $V_{DS} = -15\text{V},$ $I_D = -3.1\text{A}$		1.55		nC
Threshold Gate Charge	$Q_{G(TH)}$			2.03		
Gate-to-Source Charge	$Q_{GS}$			3.15		
Gate-to-Drain Charge	$Q_{GD}$			12.9		
<b>SWITCHING CHARACTERISTICS</b>						
Turn-On Delay Time	$t_d(ON)$	$V_{GS} = -10\text{ V},$ $V_{DS} = -15\text{ V},$ $R_L = 5\Omega,$ $R_G = 15\Omega$		9.6		ns
Rise Time	$t_r$			4.0		
Turn-Off Delay Time	$t_d(OFF)$			34.8		
Fall Time	$t_f$			7.2		
<b>BODY DIODE CHARACTERISTICS</b>						
Forward Voltage	$V_{SD}$	$V_{GS} = 0\text{ V}, I_S = -1.0\text{A}$		-0.8	-1.5	V